PIM48, 93x47 (PRESS−FIT PIN)
CASE 180CR
ISSUE A

DATE 08 DEC 2022

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

RECOMMENDED MOUNTING PATTERN

* For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

DOCUMENT NUMBER: 98AON47745H
DESCRIPTION: PIM48, 93x47 (PRESS−FIT PIN)

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